### SN54LS05, SN54S05 SN7405, SN74LS05, SN74S05 HEX INVERTERS WITH OPEN-COLLECTOR OUTPUTS

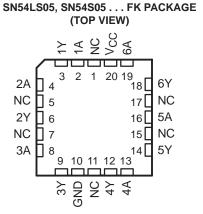
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- Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs
- Dependable Texas Instrument Quality and Reliability

SN5405, SN54LS05, SN54S05...J PACKAGE
SN7405...N PACKAGE
SN74LS05...D, DB, N, OR NS PACKAGE
SN74S05...D, N, OR NS PACKAGE

(TOP VIEW)

8 🛮 4Y



NC - No internal connection

#### description/ordering information

GND

These devices contain six independent inverters. To perform correctly, the open-collector outputs require pullup resistors. These devices may be connected to other open-collector outputs to implement active-low wired-OR or active-high wire-AND functions. Open-collector devices often are used to generate high V<sub>OH</sub> levels.

#### ORDERING INFORMATION

| TA             | PAC       | (AGE†         | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|-----------|---------------|--------------------------|---------------------|
|                |           |               | SN7405N                  | SN7405N             |
|                | PDIP – N  | Tube          | SN74LS05N                | SN74LS05N           |
|                |           |               | SN74S05N                 | SN74S05N            |
|                |           | Tube          | SN74LS05D                | 1.005               |
| 000 to 7000    | COIC D    | Tape and reel | SN74LS05DR               | LS05                |
| 0°C to 70°C    | SOIC - D  | Tube          | SN74S05D                 | 005                 |
|                |           | Tape and reel | SN74S05DR                | S05                 |
|                | COD NC    | Tana and saal | SN74LS05NSR              | 74LS05              |
|                | SOP – NS  | Tape and reel | SN74S05NSR               | 74S05               |
|                | SSOP – DB | Tape and reel | SN74LS05DBR              | LS05                |
|                | CDID      | Tubo          | SNJ54LS05J               | SNJ54LS05J          |
|                | CDIP – J  | Tube          | SNJ54S05J                | SNJ54S05J           |
| –55°C to 125°C | CDID W    | Turke         | SNJ54LS05W               | SNJ54LS05W          |
| -55°C to 125°C | CDIP – W  | Tube          | SNJ54S05W                | SNJ54S05W           |
|                | LCCC – FK | Tube          | SNJ54LS05FK              | SNJ54LS05FK         |
|                | LCCC - FK | Tube          | SNJ54S05FK               | SNJ54S05FK          |

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



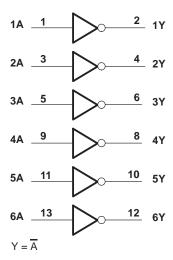
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



#### **FUNCTION TABLE** (each inverter)

| INPUT<br>A | OUTPUT<br>Y |
|------------|-------------|
| Н          | L           |
| L          | Н           |

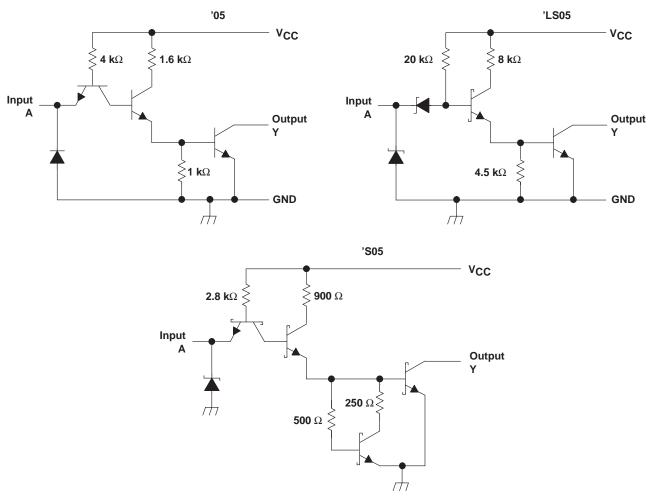
#### logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, N, and NS packages.

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#### schematic (each inverter)



Resistor values shown are nominal.

## absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

| Supply voltage, V <sub>CC</sub> (see Note 1): '05, 'LS05, '3 | S05         | 7 V              |
|--|-------------|------------------|
| Input voltage, V <sub>I</sub> : '05, 'S05                    |             | 5.5 V            |
| 'LS05  |             | 7 V              |
| Off-state output voltage, VO                                 |             | 7 V              |
| Package thermal impedance, θ <sub>JA</sub> (see Note 2):     | : D package | 86°C/W           |
|  | DB package  | 96°C/W           |
|  | N package   | 80°C/W           |
|  | NS package  | 76°C/W           |
| Storage temperature range, T <sub>stg</sub>                  |             | . −65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



NOTES: 1. Voltage values are with respect to network ground terminal.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

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#### recommended operating conditions

|                 |                                | SN5405 |     |     |      | SN7405 |      |      |
|-----------------|--------------------------------|--------|-----|-----|------|--------|------|------|
|                 |                                | MIN    | NOM | MAX | MIN  | NOM    | MAX  | UNIT |
| VCC             | Supply voltage                 | 4.5    | 5   | 5.5 | 4.75 | 5      | 5.25 | V    |
| VIH             | High-level input voltage       | 2      |     |     | 2    |        |      | V    |
| ٧ <sub>IL</sub> | Low-level input voltage        |        |     | 0.8 |      |        | 0.8  | V    |
| VOH             | High-level output voltage      |        |     | 5.5 |      |        | 5.5  | V    |
| l <sub>OL</sub> | Low-level output current       |        |     | 16  |      |        | 16   | mA   |
| TA              | Operating free-air temperature | -55    |     | 125 | 0    |        | 70   | °C   |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 |                              |   |     | SN5405           |      |     | SN7405           |      |      |
|-----------------|------------------------------|---|-----|------------------|------|-----|------------------|------|------|
| PARAMETER       | TEST CONDITIONS <sup>†</sup> |   | MIN | TYP <sup>‡</sup> | MAX  | MIN | TYP <sup>‡</sup> | MAX  | UNIT |
| VIK             | V <sub>CC</sub> = MIN,       | $I_I = -12 \text{ mA}$                            |     |                  | -1.5 |     |                  | -1.5 | V    |
| 1               | \/ NAINI                     | V <sub>IL</sub> = 0.8 V                           |     |                  |      |     |                  | 0.25 | A    |
| ЮН              | $V_{CC} = MIN,$              | $V_{OH} = 5.5 \text{ V}$ $V_{IL} = 0.7 \text{ V}$ |     |                  | 0.25 |     |                  |      | mA   |
| V <sub>OL</sub> | V <sub>CC</sub> = MIN,       | $V_{IH} = 2 V$ , $I_{OL} = 16 \text{ mA}$         |     | 0.2              | 0.4  |     | 0.2              | 0.4  | V    |
| IĮ              | V <sub>CC</sub> = MAX,       | V <sub>I</sub> = 5.5 V                            |     |                  | 1    |     |                  | 1    | mA   |
| lН              | V <sub>CC</sub> = MAX,       | V <sub>I</sub> = 2.4 V                            |     |                  | 40   |     |                  | 40   | μΑ   |
| I <sub>IL</sub> | V <sub>CC</sub> = MAX,       | V <sub>I</sub> = 0.4 V                            |     |                  | -1.6 |     |                  | -1.6 | mA   |
| ІССН            | V <sub>CC</sub> = MAX,       | V <sub>I</sub> = 0 V                              |     | 6                | 12   |     | 6                | 12   | mA   |
| ICCL            | $V_{CC} = MAX$ ,             | V <sub>I</sub> = 4.5 V                            |     | 18               | 33   |     | 18               | 33   | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see Figure 1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CO                | NDITIONS               | MIN | TYP | MAX | UNIT |
|------------------|-----------------|----------------|------------------------|------------------------|-----|-----|-----|------|
| <sup>t</sup> PLH |                 | V              | $R_L = 4 k\Omega$      | 0 45 5                 |     | 40  | 55  |      |
| t <sub>PHL</sub> | А               | Y              | R <sub>L</sub> = 400 Ω | C <sub>L</sub> = 15 pF |     | 8   | 15  | ns   |

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

#### recommended operating conditions

|                 |                                | SN54LS05 SN74LS05 |     |     | 5    |     |      |      |
|-----------------|--------------------------------|-------------------|-----|-----|------|-----|------|------|
|                 |                                | MIN               | NOM | MAX | MIN  | NOM | MAX  | UNIT |
| VCC             | Supply voltage                 | 4.5               | 5   | 5.5 | 4.75 | 5   | 5.25 | V    |
| ٧ <sub>IH</sub> | High-level input voltage       | 2                 |     |     | 2    |     |      | V    |
| ٧ <sub>IL</sub> | Low-level input voltage        |                   |     | 0.7 |      |     | 8.0  | V    |
| Vон             | High-level output voltage      |                   |     | 5.5 |      |     | 5.5  | V    |
| l <sub>OL</sub> | Low-level output current       |                   |     | 4   |      |     | 8    | mA   |
| TA              | Operating free-air temperature | -55               |     | 125 | 0    |     | 70   | °C   |

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                |                        |                         | +                       | S   | N54LS0           | 5    | S   | N74LS0           | 5    |      |
|----------------|------------------------|-------------------------|-------------------------|-----|------------------|------|-----|------------------|------|------|
| PARAMETER      |                        | TEST CONDITIONS         | I                       | MIN | TYP <sup>‡</sup> | MAX  | MIN | TYP <sup>‡</sup> | MAX  | UNIT |
| VIK            | V <sub>CC</sub> = MIN, | I <sub>I</sub> = -18 mA |                         |     |                  | -1.5 |     |                  | -1.5 | V    |
| ЮН             | V <sub>CC</sub> = MIN, | $V_{IL} = MAX$ ,        | V <sub>OH</sub> = 5.5 V |     |                  | 0.1  |     |                  | 0.1  | mA   |
| .,             | N/ BAIN!               |                         | I <sub>OL</sub> = 4 mA  |     | 0.25             | 0.4  |     | 0.25             | 0.4  | .,   |
| VOL            | $V_{CC} = MIN,$        | V <sub>IH</sub> = 2 V   | $I_{OL} = 8 \text{ mA}$ |     |                  |      |     | 0.35             | 0.5  | V    |
| l <sub>l</sub> | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 7 V    |                         |     |                  | 0.1  |     |                  | 0.1  | mA   |
| lіН            | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 2.7 V  |                         |     |                  | 20   |     |                  | 20   | μΑ   |
| I₁∟            | $V_{CC} = MAX$ ,       | V <sub>I</sub> = 0.4 V  |                         |     |                  | -0.4 |     |                  | -0.4 | mA   |
| Іссн           | $V_{CC} = MAX$ ,       | V <sub>I</sub> = 0 V    |                         |     | 1.2              | 2.4  |     | 1.2              | 2.4  | mA   |
| ICCL           | $V_{CC} = MAX$ ,       | V <sub>I</sub> = 4.5 V  | _                       |     | 3.6              | 6.6  |     | 3.6              | 6.6  | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 2)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                   | MIN | TYP | MAX | UNIT |
|------------------|-----------------|----------------|-----------------------------------|-----|-----|-----|------|
| t <sub>PLH</sub> |                 | V              | D 010 0 45 = 5                    |     | 17  | 32  |      |
| t <sub>PHL</sub> | А               | Y              | $R_L = 2 k\Omega$ , $C_L = 15 pF$ |     | 15  | 28  | ns   |

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

#### recommended operating conditions

|                 |                                | S   | N54S05 |     | 9    | N74S05 | 1    | LINUT |
|-----------------|--------------------------------|-----|--------|-----|------|--------|------|-------|
|                 |                                | MIN | NOM    | MAX | MIN  | NOM    | MAX  | UNIT  |
| VCC             | Supply voltage                 | 4.5 | 5      | 5.5 | 4.75 | 5      | 5.25 | V     |
| VIH             | High-level input voltage       | 2   |        |     | 2    |        |      | V     |
| VIL             | Low-level input voltage        |     |        | 0.8 |      |        | 0.8  | V     |
| Vон             | High-level output voltage      |     |        | 5.5 |      |        | 5.5  | V     |
| l <sub>OL</sub> | Low-level output current       |     |        | 20  |      |        | 20   | mA    |
| TA              | Operating free-air temperature | -55 |        | 125 | 0    |        | 70   | °C    |

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETER       |                        | TEGE CONDITIONS <sup>†</sup>                      | SN5   | 54S05 |      | 5   | N74S05           |      |      |
|-----------------|------------------------|---|-------|-------|------|-----|------------------|------|------|
| PARAMETER       |                        | TEST CONDITIONS†                                  | MIN T | YP‡ N | IAX  | MIN | TYP <sup>‡</sup> | MAX  | UNIT |
| VIK             | V <sub>CC</sub> = MIN, | $I_I = -18 \text{ mA}$                            |       | -     | -1.2 |     |                  | -1.2 | V    |
|                 | \/ NAINI               | V <sub>IL</sub> = 0.8 V                           |       |       |      |     |                  | 0.25 | A    |
| ІОН             | $V_{CC} = MIN,$        | $V_{OH} = 5.5 \text{ V}$ $V_{IL} = 0.7 \text{ V}$ |       | (     | ).25 |     |                  |      | mA   |
| V <sub>OL</sub> | $V_{CC} = MIN,$        | $V_{IH} = 2 V$ , $I_{OL} = 20 \text{ mA}$         |       |       | 0.5  |     |                  | 0.5  | V    |
| l <sub>l</sub>  | $V_{CC} = MAX$ ,       | V <sub>I</sub> = 5.5 V                            |       |       | 1    |     |                  | 1    | mA   |
| lн              | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 2.7 V                            |       |       | 50   |     |                  | 50   | μΑ   |
| IIL             | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 0.5 V                            |       |       | -2   |     |                  | -2   | mA   |
| ІССН            | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 0 V                              |       | 9 1   | 9.8  |     | 9                | 19.8 | mA   |
| ICCL            | $V_{CC} = MAX$ ,       | V <sub>I</sub> = 4.5 V                            |       | 30    | 54   |     | 30               | 54   | mA   |

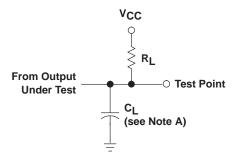
<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C (see Figure 1)

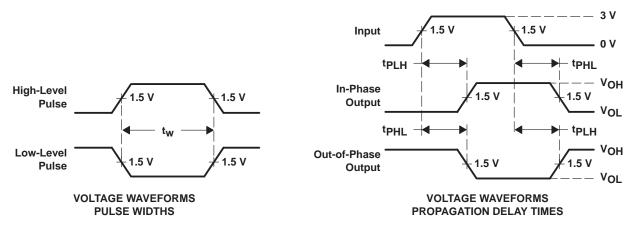
| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CO            | NDITIONS               | MIN | TYP | MAX | UNIT |
|------------------|-----------------|----------------|--------------------|------------------------|-----|-----|-----|------|
| <sup>t</sup> PLH |                 |                |                    | C <sub>L</sub> = 15 pF | 2   | 5   | 7.5 | ns   |
| <sup>t</sup> PHL | ^               | V              | D 000 0            | C[ = 15 pr             | 2   | 4.5 | 7   | 113  |
| <sup>t</sup> PLH | A               | Y              | $R_L = 280 \Omega$ | C 50 = E               |     | 7.5 |     |      |
| t <sub>PHL</sub> |                 |                |                    | $C_L = 50 pF$          |     | 7   |     | ns   |

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

## PARAMETER MEASUREMENT INFORMATION SERIES 54/74 AND 54S/74S DEVICES



LOAD CIRCUIT

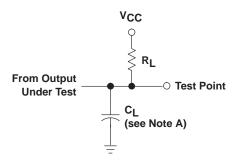


NOTES: A.  $C_L$  includes probe and jig capacitance.

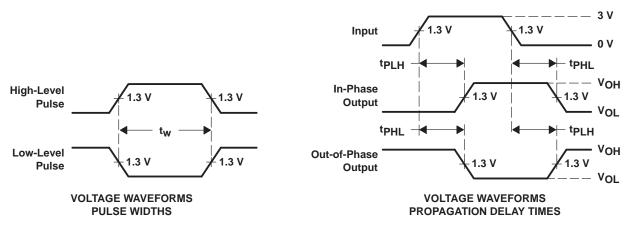
- B. In the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O$  = 50  $\Omega$ , and: For Series 54/74,  $t_f \leq$  7 ns,  $t_f \leq$  7 ns. For Series 54S/74S,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

## PARAMETER MEASUREMENT INFORMATION SERIES 54LS/74LS DEVICES



**LOAD CIRCUIT** 



NOTES: A.  $C_L$  includes probe and jig capacitance.

- B. In the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \ \Omega$ ,  $t_f \leq 1.5 \ ns$ ,  $t_f \leq 2.6 \ ns$ .
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms





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#### **PACKAGING INFORMATION**

| Orderable Device | Status   | Package Type |         | Pins |      | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Top-Side Markings    | Samples |
|------------------|----------|--------------|---------|------|------|----------------------------|------------------|--------------------|--------------|----------------------|---------|
|                  | (1)      |              | Drawing |      | Qty  | (2)                        |                  | (3)                |              | (4)                  |         |
| JM38510/07003BDA | ACTIVE   | CFP          | W       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>07003BDA | Samples |
| JM38510/07004BCA | ACTIVE   | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>07004BCA | Samples |
| M38510/07003BDA  | ACTIVE   | CFP          | W       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>07003BDA | Samples |
| M38510/07004BCA  | ACTIVE   | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | JM38510/<br>07004BCA | Samples |
| SN54LS05J        | ACTIVE   | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SN54LS05J            | Samples |
| SN54S05J         | ACTIVE   | CDIP         | J       | 14   | 1    | TBD                        | A42              | N / A for Pkg Type | -55 to 125   | SN54S05J             | Samples |
| SN7405D          | OBSOLETI | SOIC         | D       | 14   |      | TBD                        | Call TI          | Call TI            | 0 to 70      |                      |         |
| SN7405DR         | OBSOLETI | SOIC         | D       | 14   |      | TBD                        | Call TI          | Call TI            | 0 to 70      |                      |         |
| SN7405N          | ACTIVE   | PDIP         | N       | 14   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN7405N              | Samples |
| SN7405N3         | OBSOLET  | PDIP         | N       | 14   |      | TBD                        | Call TI          | Call TI            | 0 to 70      |                      |         |
| SN7405NE4        | ACTIVE   | PDIP         | N       | 14   | 25   | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type | 0 to 70      | SN7405N              | Samples |
| SN74LS05D        | ACTIVE   | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS05                 | Samples |
| SN74LS05DBLE     | OBSOLETI | E SSOP       | DB      | 14   |      | TBD                        | Call TI          | Call TI            | 0 to 70      |                      |         |
| SN74LS05DBR      | ACTIVE   | SSOP         | DB      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS05                 | Samples |
| SN74LS05DBRE4    | ACTIVE   | SSOP         | DB      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS05                 | Samples |
| SN74LS05DBRG4    | ACTIVE   | SSOP         | DB      | 14   | 2000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS05                 | Samples |
| SN74LS05DE4      | ACTIVE   | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS05                 | Samples |
| SN74LS05DG4      | ACTIVE   | SOIC         | D       | 14   | 50   | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS05                 | Samples |
| SN74LS05DR       | ACTIVE   | SOIC         | D       | 14   | 2500 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM | 0 to 70      | LS05                 | Samples |





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| Orderable Device | Status   | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp                 | Op Temp (°C) | Top-Side Markings | Sample |
|------------------|----------|--------------|--------------------|------|----------------|----------------------------|------------------|-------------------------------|--------------|-------------------|--------|
| SN74LS05DRE4     | ACTIVE   | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | LS05              | Sample |
| SN74LS05DRG4     | ACTIVE   | SOIC         | D                  | 14   | 2500           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | LS05              | Sample |
| SN74LS05N        | ACTIVE   | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type            | 0 to 70      | SN74LS05N         | Sample |
| SN74LS05N3       | OBSOLETE | PDIP         | N                  | 14   |                | TBD                        | Call TI          | Call TI                       | 0 to 70      |                   |        |
| SN74LS05NE4      | ACTIVE   | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type            | 0 to 70      | SN74LS05N         | Sample |
| SN74LS05NSR      | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | 74LS05            | Sample |
| SN74LS05NSRG4    | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | 74LS05            | Sample |
| SN74S05D         | ACTIVE   | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | S05               | Sampl  |
| SN74S05DE4       | ACTIVE   | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | S05               | Sampl  |
| SN74S05DG4       | ACTIVE   | SOIC         | D                  | 14   | 50             | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | S05               | Sampl  |
| SN74S05N         | ACTIVE   | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type            | 0 to 70      | SN74S05N          | Sampl  |
| SN74S05N3        | OBSOLETE | PDIP         | N                  | 14   |                | TBD                        | Call TI          | Call TI                       | 0 to 70      |                   |        |
| SN74S05NE4       | ACTIVE   | PDIP         | N                  | 14   | 25             | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type            | 0 to 70      | SN74S05N          | Samp   |
| SN74S05NSR       | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | 74S05             | Sampl  |
| SN74S05NSRE4     | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM            | 0 to 70      | 74S05             | Sampl  |
| SN74S05NSRG4     | ACTIVE   | SO           | NS                 | 14   | 2000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM 0 to 70    |              | 74S05             | Sampl  |
| SNJ54LS05FK      | ACTIVE   | LCCC         | FK                 | 20   | 1              | TBD                        | POST-PLATE       | N / A for Pkg Type -55 to 125 |              | SNJ54LS<br>05FK   | Samp   |
| SNJ54LS05J       | ACTIVE   | CDIP         | J                  | 14   | 1              | TBD                        | A42              | N / A for Pkg Type            | -55 to 125   | SNJ54LS05J        | Sampl  |
| SNJ54LS05W       | ACTIVE   | CFP          | W                  | 14   | 1              | TBD                        | A42              | N / A for Pkg Type            | -55 to 125   | SNJ54LS05W        | Samp   |



#### PACKAGE OPTION ADDENDUM

11-Apr-2013

| Orderable Device | Status | Package Type | _       | Pins | _   | Eco Plan | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Top-Side Markings | Samples |
|------------------|--------|--------------|---------|------|-----|----------|------------------|--------------------|--------------|-------------------|---------|
|                  | (1)    |              | Drawing |      | Qty | (2)      |                  | (3)                |              | (4)               |         |
| SNJ54S05FK       | ACTIVE | LCCC         | FK      | 20   | 1   | TBD      | POST-PLATE       | N / A for Pkg Type | -55 to 125   | SNJ54S<br>05FK    | Samples |
| SNJ54S05J        | ACTIVE | CDIP         | J       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ54S05J         | Samples |
| SNJ54S05W        | ACTIVE | CFP          | W       | 14   | 1   | TBD      | A42              | N / A for Pkg Type | -55 to 125   | SNJ54S05W         | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL. Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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#### OTHER QUALIFIED VERSIONS OF SN54LS05, SN54S05, SN74O5, SN74LS05, SN74S05:

Catalog: SN74LS05, SN74S05





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• Military: SN5405, SN54LS05, SN54S05

NOTE: Qualified Version Definitions:

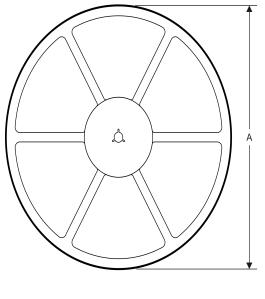
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## PACKAGE MATERIALS INFORMATION

14-Jul-2012 www.ti.com

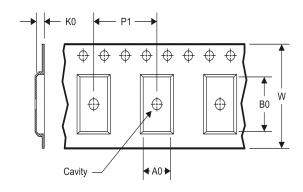
#### TAPE AND REEL INFORMATION

#### **REEL DIMENSIONS**





#### **TAPE DIMENSIONS**



| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

#### TAPE AND REEL INFORMATION

#### \*All dimensions are nominal

| All dimensions are nominal |      |                    |    |      |                          |                          |            |            |            |            |           |                  |
|----------------------------|------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                     | _    | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74LS05DBR                | SSOP | DB                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 6.6        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74LS05DR                 | SOIC | D                  | 14 | 2500 | 330.0                    | 16.4                     | 6.5        | 9.0        | 2.1        | 8.0        | 16.0      | Q1               |
| SN74LS05NSR                | SO   | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| SN74S05NSR                 | SO   | NS                 | 14 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |

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\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS05DBR | SSOP         | DB              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74LS05DR  | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74LS05NSR | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74S05NSR  | SO           | NS              | 14   | 2000 | 367.0       | 367.0      | 38.0        |

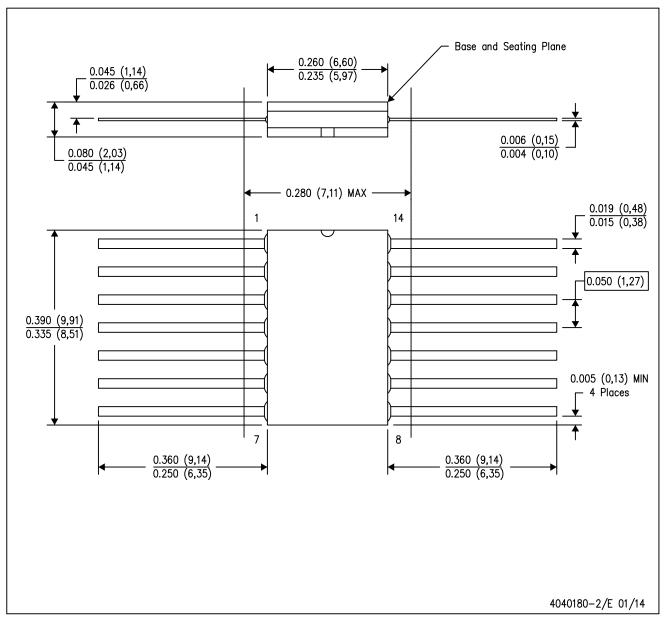
### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## W (R-GDFP-F14)

## CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



## D (R-PDSO-G14)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



## D (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



#### **MECHANICAL DATA**

## NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

#### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



#### DB (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE

#### **28 PINS SHOWN**



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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